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2) TOSHIBA MATERIALS CO., LTD.

Address: 1) 1-1, Shibaura 1-chome, Minato-ku
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Oblon, Spivak, McClelland, Maier & Neustadt, P.C., 1940 Duke Street, Alexandria, VA 22314

[1st Inventor]

Residence Address: Yokohama-shi, Japan

Mailing Address: c/o Engineering Management Group Development Dept., TOSHIBA MATERIALS CO., LTD., 8, Shinsugita-cho, Isogo-ku, Yokohama-shi, Kanagawa 235-8522 Japan

Citizenship: Japan

Michiyasu Komatsu

JAN. 27. 2006

Michiyasu Komatsu

Date:

[2nd Inventor]

Residence Address:

Mailing Address:

Citizenship:

Date:

[3rd Inventor]

Residence Address:

Mailing Address:

Citizenship:

Date:

[4th Inventor]

Residence Address:

Mailing Address:

Citizenship:

Date:

[5th Inventor]

Residence Address:

Mailing Address:

Citizenship:

Date: